

Features

- Low profile package
- Ideal for automated placement
- Ultrafast reverse recovery time
- Low power losses, high efficiency
- Low forward voltage drop
- High surge capability
- High temperature soldering:
260°C/10 seconds at terminals
- Component in accordance to
RoHS 2002/95/1 and WEEE 2002/96/EC



MSMA

Mechanical Data

- **Case:** MSMA molded plastic
- **Terminals:** Solder plated, solderable per
JESD22-B102
- **Polarity:** Laser band denotes cathode end

Major Ratings and Characteristics

$I_{F(AV)}$	2.0 A
V_{RRM}	20 V, 30V, 40V
I_{FSM}	50 A
V_F	0.40V
$T_j \text{ max.}$	125 °C

Maximum Ratings & Thermal Characteristics

($T_A = 25\text{ °C}$ unless otherwise noted)

Items	Symbol	MASL22	MASL23	MASL24	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	V
Maximum RMS voltage	V_{RMS}	14	21	28	V
Maximum DC blocking voltage	V_{DC}	20	30	40	V
Maximum average forward rectified current	$I_{F(AV)}$	2			A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	50			A
Voltage rate of change (rated V_R)	dv/dt	10000			V/ μ s
Thermal resistance from junction to lead ⁽¹⁾	$R_{\theta JL}$	35			°C/W
Operating junction and storage temperature range	T_J, T_{STG}	-65 to +125			°C

Note 1: Mounted on P.C.B. with 0.2 x 0.2" (5.0 x 5.0mm) copper pad areas.

Electrical Characteristics

($T_A = 25\text{ °C}$ unless otherwise noted)

Items	Test conditions		Symbol	Min	Type	Max	UNIT
Instantaneous forward voltage	$I_F=2.0A^{(2)}$		V_F	-	-	0.40	V
Reverse current	$V_R=V_{DC}$	$T_J=25\text{ °C}$ $T_J=100\text{ °C}$	I_R	-	-	0.5 10	mA

Note 2: Pulse test:300 μ s pulse width,1% duty cycle.

Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

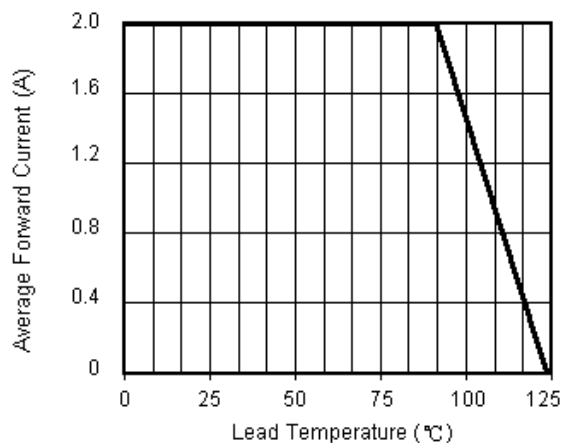


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

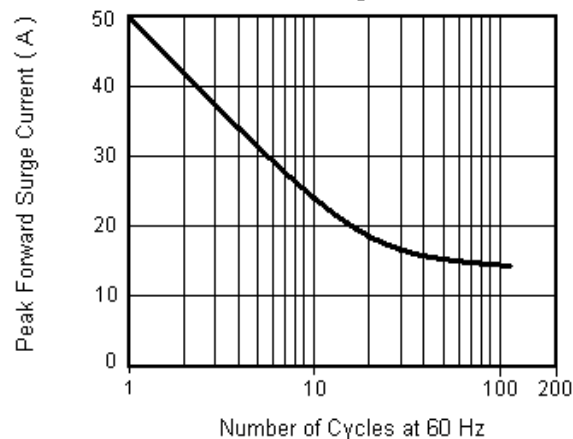


Fig.3 Typical Instantaneous Forward Characteristics

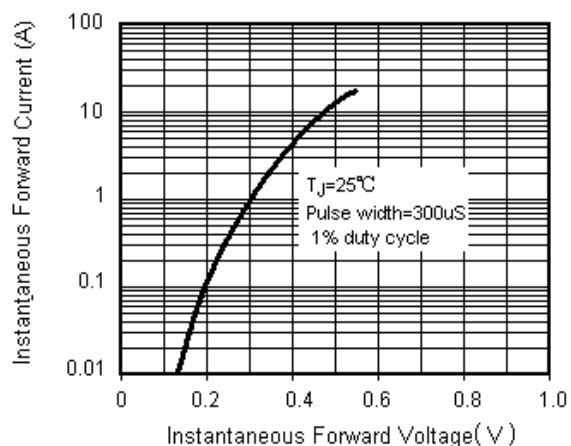
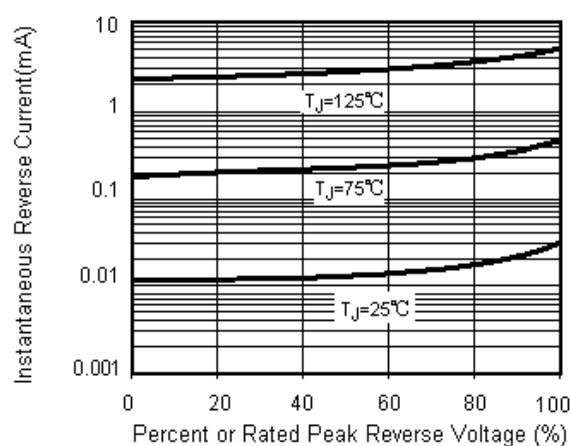
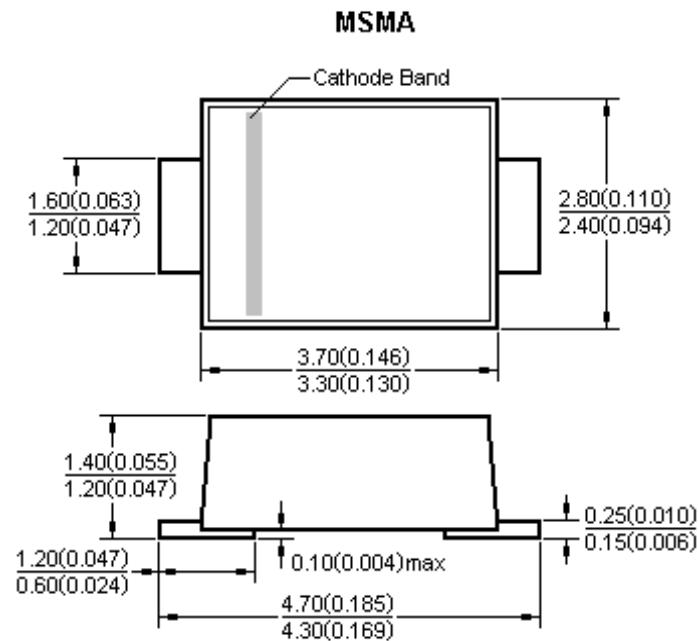


Fig.4 Typical Reverse Leakage Characteristics



Package Outline**Notice**

- Product is intended for use in general electronics applications.
- Product should be worked less than the ratings; if exceeded, may cause permanent damage or introduce latent failure mechanisms.
- The absolute maximum ratings are rated values and must not be exceeded during operation. The following are the general derating methods you design a circuit with a device.

$I_{F(AV)}$: We recommend that the worst case current be no greater than 80% .

T_J : Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a T_J of below 100°C.

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